

U.S. UTILITY Patent Application

CHIPIE

APPLICATION NO: 09/975920	CONT/PRIOR F	CLASS 156 359	SUBCLASS 82i	ART UNIT 1734 2873	EXAMINER MACK
APPLICANTS Thomas Dieker					
TITLE Temperature compensation apparatus for thermally loaded bodies of low thermal conductivity					

ISSUING CLASSIFICATION

CROSS REFERENCE(S)

<input type="checkbox"/> TERMINAL DISCLAIMER		DRAWINGS			CLAIMS ALLOWED	
<input type="checkbox"/> Sheets Drwg. <input type="checkbox"/> Figs. Drwg. <input type="checkbox"/> Print Fig.		<input type="checkbox"/> Total Claims <input type="checkbox"/> Print Claim for O.C.				
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